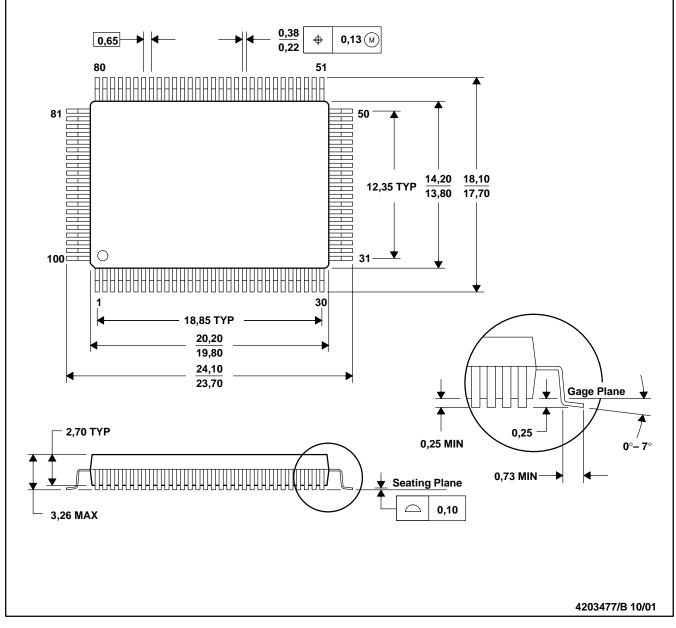
MECHANICAL DATA

MPQF111A - OCTOBER 2001 - REVISED NOVEMBER 2001

PJU (R-PQFP-G100)

PLASTIC QUAD FLATPACK



NOTES: A. All linear dimensions are in millimeters. B. This drawing is subject to change without notice.



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